

### General Description

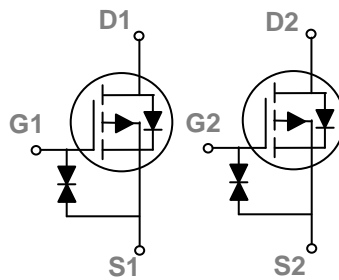
These dual P Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BVDSS	RDSON	ID
-20V	600mΩ	-400mA

### Features

- Fast switching
- Green Device Available
- Suit for 1.5V Gate Drive Applications

### SOT563 Dual Pin Configuration



### Applications

- Notebook
- Load Switch
- Networking
- Hand-held Instruments

### Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	-20	V
$V_{GS}$	Gate-Source Voltage	$\pm 8$	V
$I_D$	Drain Current – Continuous ( $T_c=25^\circ\text{C}$ )	-400	mA
	Drain Current – Continuous ( $T_c=100^\circ\text{C}$ )	-250	mA
$I_{DM}$	Drain Current – Pulsed <sup>1</sup>	-1.6	A
$P_D$	Power Dissipation ( $T_c=25^\circ\text{C}$ )	312	mW
	Power Dissipation – Derate above $25^\circ\text{C}$	2.5	mW/ $^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
$T_J$	Operating Junction Temperature Range	-55 to 150	$^\circ\text{C}$

### Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	400	$^\circ\text{C}/\text{W}$

**Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)**
**Off Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=-250\mu A$	-20	---	---	V
$\Delta BV_{DSS}/\Delta T_J$	$BV_{DSS}$ Temperature Coefficient	Reference to $25^\circ\text{C}$ , $I_D=-1\text{mA}$	---	-0.01	---	$V/^\circ\text{C}$
$I_{DSS}$	Drain-Source Leakage Current	$V_{DS}=-20V, V_{GS}=0V, T_J=25^\circ\text{C}$	---	---	-1	$\mu A$
		$V_{DS}=-16V, V_{GS}=0V, T_J=125^\circ\text{C}$	---	---	-10	$\mu A$
$I_{GSS}$	Gate-Source Leakage Current	$V_{GS}=\pm 8V, V_{DS}=0V$	---	---	$\pm 20$	$\mu A$

**On Characteristics**

$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=-4.5V, I_D=-0.3A$	---	440	600	m $\Omega$
		$V_{GS}=-2.5V, I_D=-0.2A$	---	610	850	
		$V_{GS}=-1.8V, I_D=-0.1A$	---	810	1200	
		$V_{GS}=-1.5V, I_D=-0.1A$	---	1020	1600	
		$V_{GS}=-1.2V, I_D=-0.1A$	---	1800	3000	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}, I_D=-250\mu A$	-0.3	-0.6	-1.0	V
$\Delta V_{GS(th)}$	$V_{GS(th)}$ Temperature Coefficient		---	3	---	$mV/^\circ\text{C}$

**Dynamic and switching Characteristics**

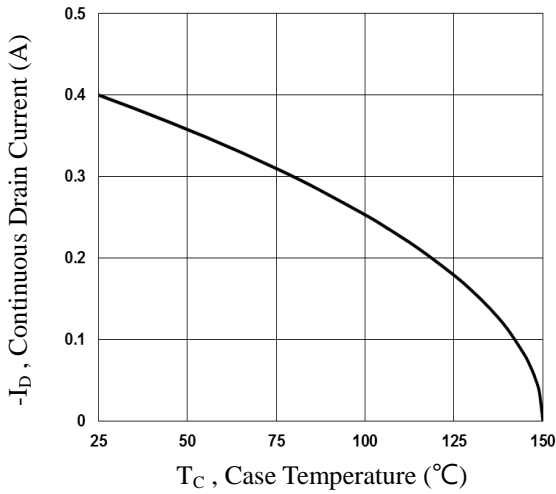
$Q_g$	Total Gate Charge <sup>2,3</sup>	$V_{DS}=-10V, V_{GS}=-4.5V, I_D=-0.2A$	---	1	2	nC
$Q_{gs}$	Gate-Source Charge <sup>2,3</sup>		---	0.28	0.5	
$Q_{gd}$	Gate-Drain Charge <sup>2,3</sup>		---	0.18	0.4	
$T_{d(on)}$	Turn-On Delay Time <sup>2,3</sup>	$V_{DD}=-10V, V_{GS}=-4.5V, R_G=10\Omega, I_D=-0.2A$	---	8	16	ns
$T_r$	Rise Time <sup>2,3</sup>		---	5.2	10	
$T_{d(off)}$	Turn-Off Delay Time <sup>2,3</sup>		---	30	60	
$T_f$	Fall Time <sup>2,3</sup>		---	18	36	
$C_{iss}$	Input Capacitance	$V_{DS}=-10V, V_{GS}=0V, F=1\text{MHz}$	---	40	78	pF
$C_{oss}$	Output Capacitance		---	15	30	
$C_{rss}$	Reverse Transfer Capacitance		---	6.5	13	

**Drain-Source Diode Characteristics and Maximum Ratings**

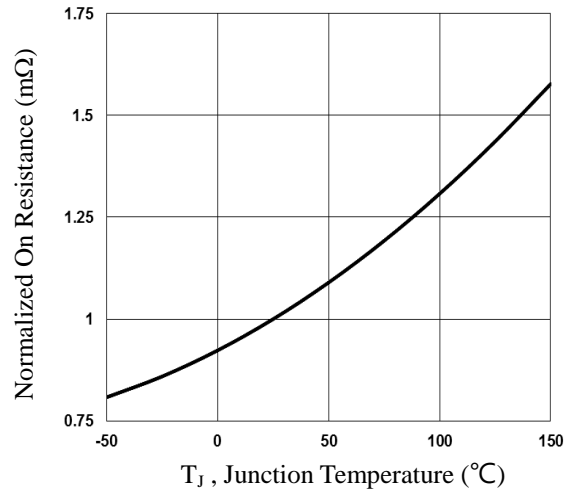
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_S$	Continuous Source Current	$V_G=V_D=0V$ , Force Current	---	---	-0.4	A
$I_{SM}$	Pulsed Source Current		---	---	-0.8	A
$V_{SD}$	Diode Forward Voltage	$V_{GS}=0V, I_S=-0.2A, T_J=25^\circ\text{C}$	---	---	-1	V

Note :

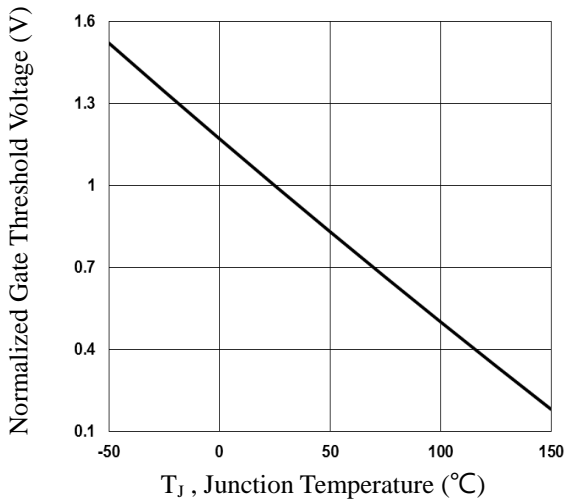
1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed, pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
3. Essentially independent of operating temperature.



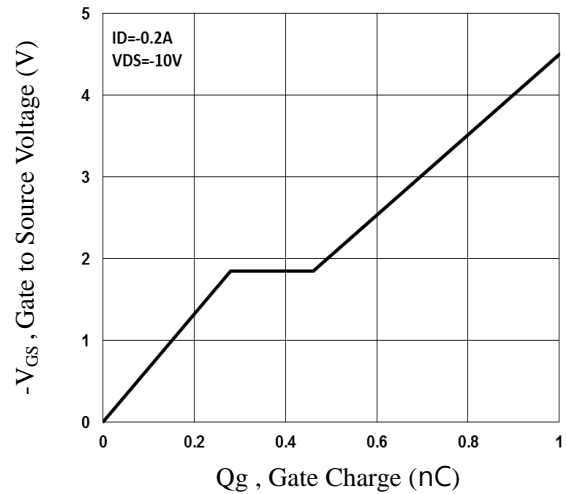
**Fig.7 Continuous Drain Current vs.  $T_c$**



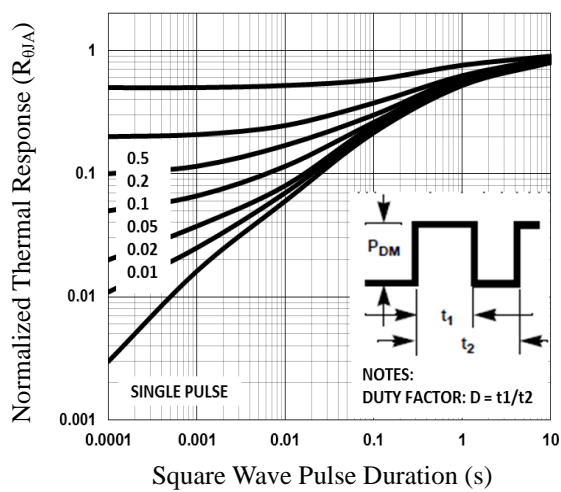
**Fig.8 Normalized  $R_{DS(on)}$  vs.  $T_j$**



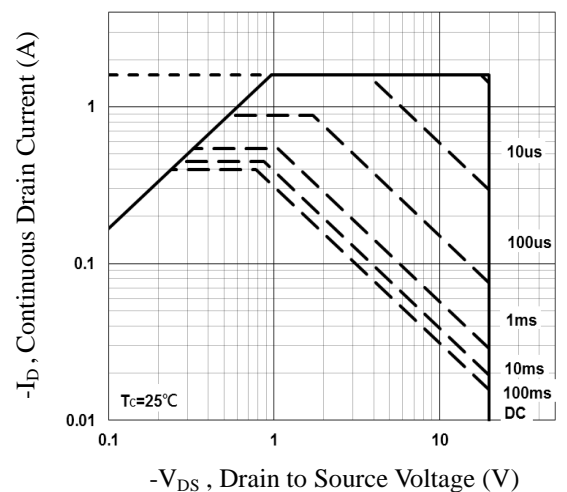
**Fig.9 Normalized  $V_{th}$  vs.  $T_j$**



**Fig.10 Gate Charge Waveform**

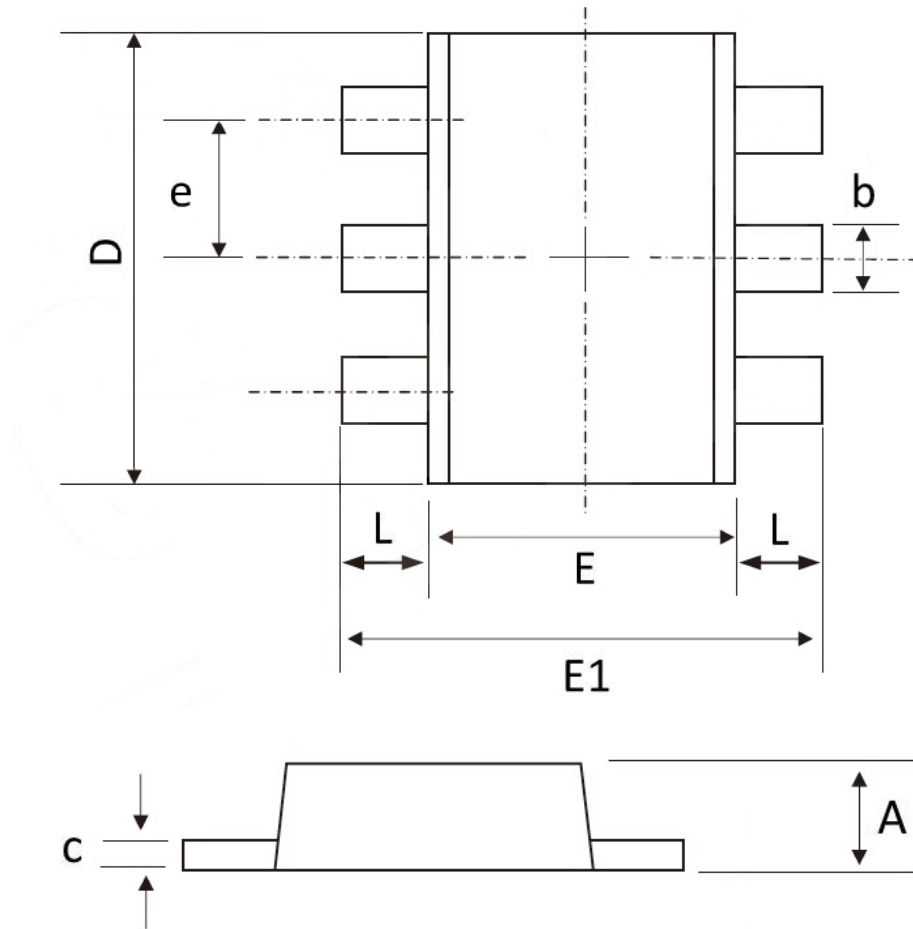


**Fig.11 Normalized Transient Impedance**



**Fig.12 Maximum Safe Operation Area**

### SOT563 Dual PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	0.600	0.500	0.024	0.020
b	0.300	0.150	0.012	0.006
c	0.180	0.100	0.007	0.004
D	1.700	1.500	0.067	0.059
E	1.250	1.100	0.049	0.043
E1	1.700	1.550	0.067	0.061
e	0.5BSC		0.02BSC	
L	0.300	0.100	0.012	0.004